Special Issue

Recent Advances in 3D Printing Technologies in Bioengineering with Selected Papers from the 29th Congress of the European Society of Biomechanics (ESB 2024)

Message from the Guest Editors

This Special Issue of the *Journal of Manufacturing and* Materials Processing includes a selection of papers on this very interesting topic of "Recent Advances in 3D Printing Technologies in Bioengineering" from scientists across the globe, as well as extended versions of selected papers presented at the 29th Congress of the European Society of Biomechanics (ESB 2024) taking place in Edinburgh, Scotland, from 30th June to 3rd July 2024 (https://esbiomech2024.org/), which brings together experts from industry and research from all over the world. Contributors from around the world can submit their manuscripts for consideration as normal. Participants of ESB 2024 can approach/contact the three editors of this Special Issue who are handling the selection of high-quality works from the conference. These papers will be submitted as extended full versions of their original papers (50% expansion of the contents of the conference paper).

Guest Editors

Dr. Bin Zhang

Dr. Amirpasha Moetazedian

Prof. Dr. Peter Zioupos

Deadline for manuscript submissions

31 December 2025



Journal of Manufacturing and Materials Processing

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About the Journal

Message from the Editor-in-Chief

Journal of Manufacturing and Materials Processing (JMMP)(ISSN 2504-4494) is a new MDPI peer-reviewed, open access venue with a focus on the scientific fundamentals and engineering methodologies of manufacturing and materials processing. We offer an online platform facilitating effective exchange of innovative scientific and engineering ideas and the dissemination of recent, original, and significant research and developmental findings. On behalf of the Editorial Board, I extend an invitation to our scientific and engineering colleagues to contribute high-quality, innovative, and ground-breaking research articles to .IMMP.

Editor-in-Chief

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